

# S1A THRU S1M

## 1.0 AMP. Surface Mount Rectifiers



Voltage Range 50 to 1000 Volts Current 1.0 Ampere

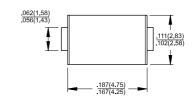
## **Features**

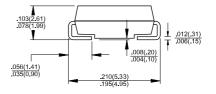
- ♦ For surface mounted application
- Glass passivated junction chip.
- Low forward voltage drop
- High current capability
- → Fight current capability
   → Easy pick and place
- High surge current capability
- Plastic material used carries Underwriters Laboratory Classification 94V-O
- High temperature soldering:
   250°C / 10 seconds at terminals

## **Mechanical Data**

- ♦ Case: Molded plastic♦ Terminals: Solder plated
- ♦ Polarity: Indicated by cathode band
- ♦ Packaging: 12mm tape per EIA STD RS-481
- ♦ Weight: 0.064 gram

### SMA/DO-214AC





Dimensions in inches and (millimeters)

# **Maximum Ratings and Electrical Characteristics**

Rating at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, 60 Hz, resistive or inductive load.

For capacitive load, derate current by 20%

Type Number	S1A	S1B	S1D	S1G	S1J	S1K	S1M	Units
Maximum Recurrent Peak Reverse Voltage	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current @T <sub>L</sub> =110°C	1.0							Α
Peak Forward Surge Current, 8.3 ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	30							А
Maximum Instantaneous Forward Voltage  @ 1.0A	1.1							V
Maximum DC Reverse Current @ T <sub>A</sub> =25°C	5 50						uA	
at Rated DC Blocking Voltage @ T <sub>A</sub> =125°C							uA	
Maximum Reverse Recovery Time ( Note 1 )	1.8							uS
Typical Junction Capacitance (Note 2)	12							pF
Operating Temperature Range T <sub>J</sub>	-55 to +150							°C
Storage Temperature Range TSTG	-55 to +150							°C

Notes: 1. Reverse Recovery Test Conditions:  $I_F$ =0.5A,  $I_R$ =1.0A,  $I_{RR}$ =0.25A

2. Measured at 1 MHz and Applied V<sub>R</sub>=4.0 Volts



### RATINGS AND CHARACTERISTIC CURVES (SIA THRU SIM)

FIG.1- MAXIMUM FORWARD CURRENT DERATING 1.2 € 1.0 AVERAGE FORWARD CURRENT. .20IN<sup>2</sup> (5.0mm<sup>2</sup>) x 0.5mil inches(0.013mm) Thick Copper Pad Areas 0.8 0.6 0.4 0.2 0 0 20 40 60 80 100 120 140 LEAD TEMPERATURE. (°C)

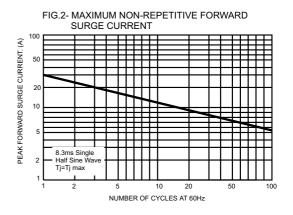
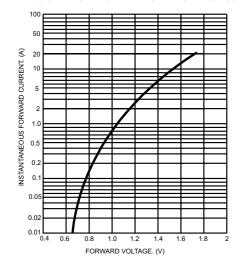


FIG.3- TYPICAL FORWARD CHARACTERISTICS





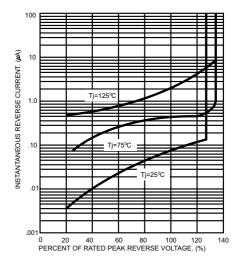


FIG.5- TYPICAL JUNCTION CAPACITANCE

